

# Device Modeling Report

COMPONENTS:THYRISTOR  
PART NUMBER:MCR310-2  
MANUFACTURER: MOTOROLA SEMICONDUCTOR



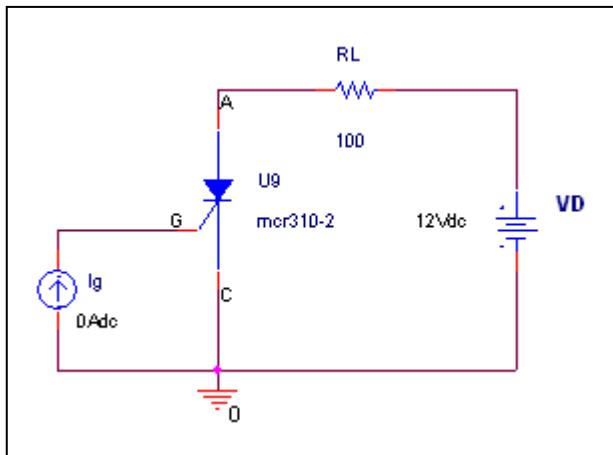
**Bee Technologies Inc.**

## DIODE MODEL

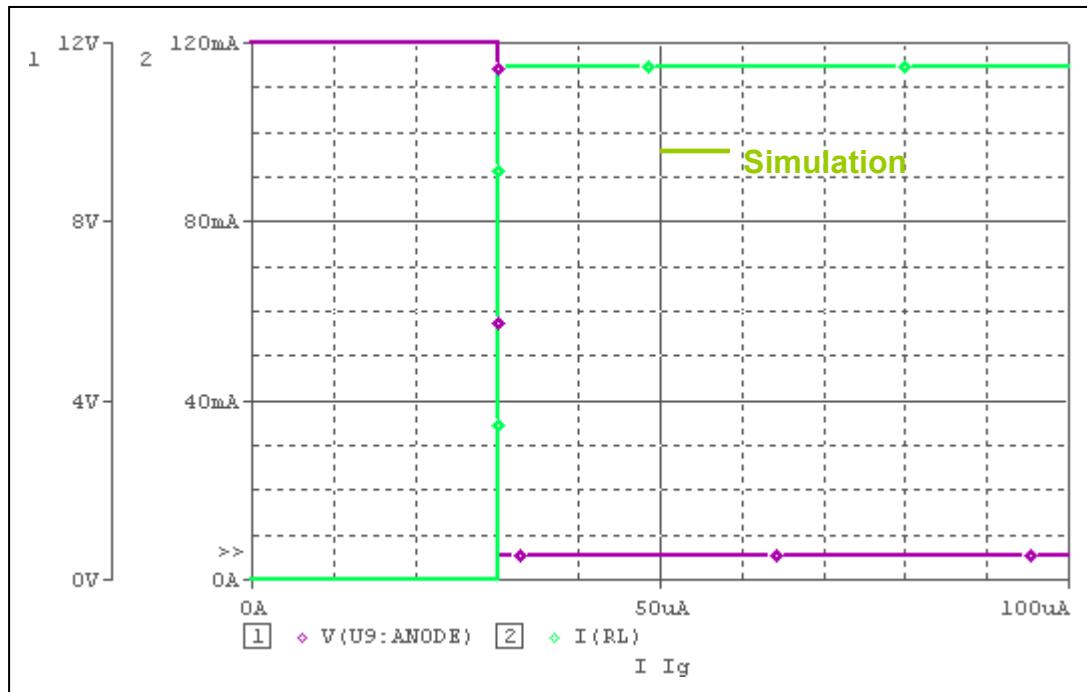
Pspice model Parameter	Model description
IS	Saturation Current
N	Emission Coefficient
RS	Series Resistance
IKF	High-injection Knee Current
CJO	Zero-bias Junction Capacitance
M	Junction Grading Coefficient
VJ	Junction Potential
ISR	Recombination Current Saturation Value
BV	Reverse Breakdown Voltage(a positive value)
IBV	Reverse Breakdown Current(a positive value)
TT	Transit Time

## IG-VT Characteristic

Evaluation Circuit



Simulation result

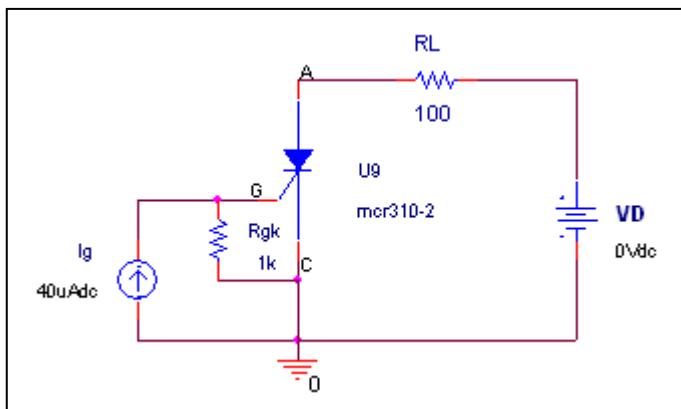


Comparison Table

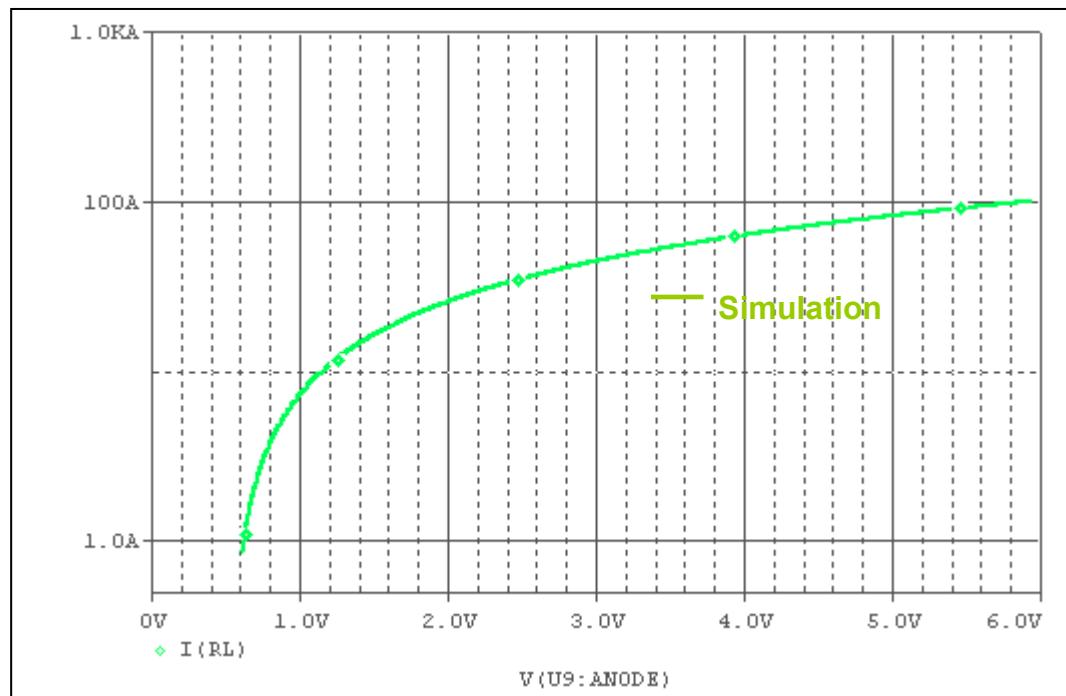
	Measurement	Simulation	% Error
$I_{G_T}$ ( $\mu$ A)	30	30.238	0.79333
$V_{G_T}$ (V)	0.5	0.519002	3.80040

## ITM-VTM Characteristic

Evaluation Circuit



Simulation result

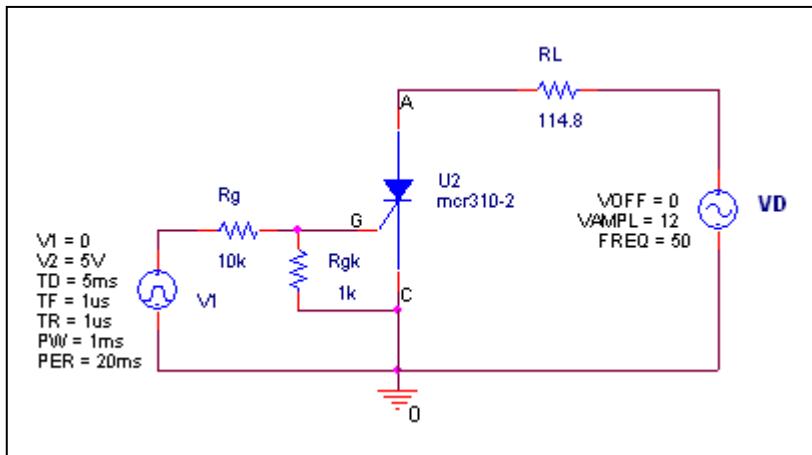


Comparison Table

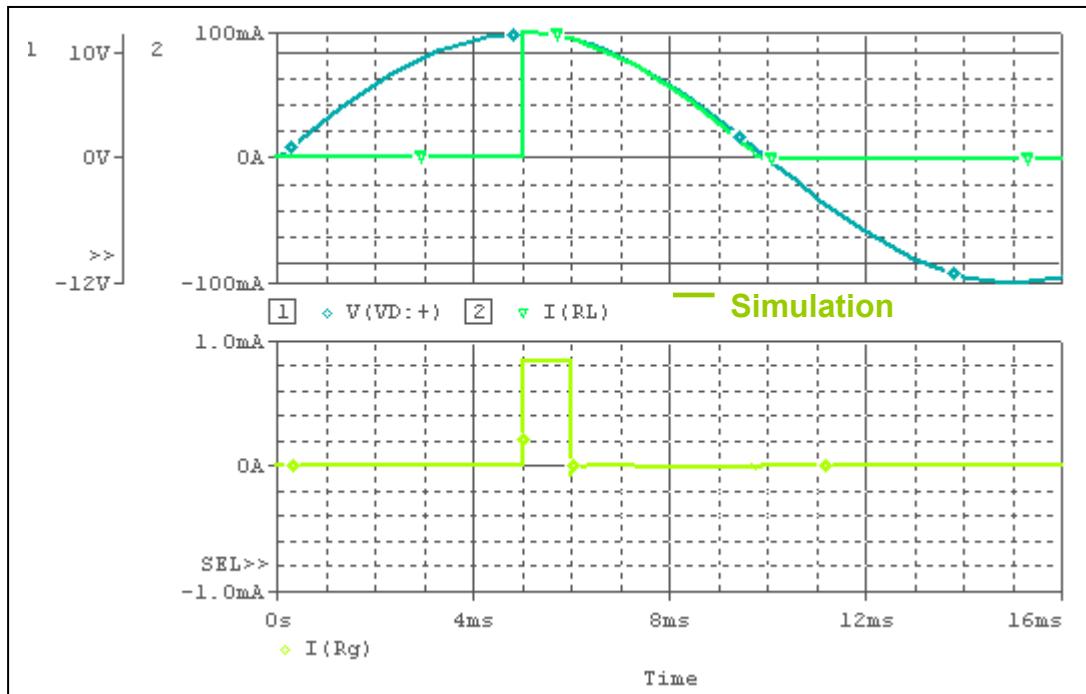
At ITM=20A	Measurement	Simulation	% Error
VTM(V)	1.7	1.6980	-0.1176

## Holding Characteristic (IH)

### Evaluation Circuit



### Simulation result

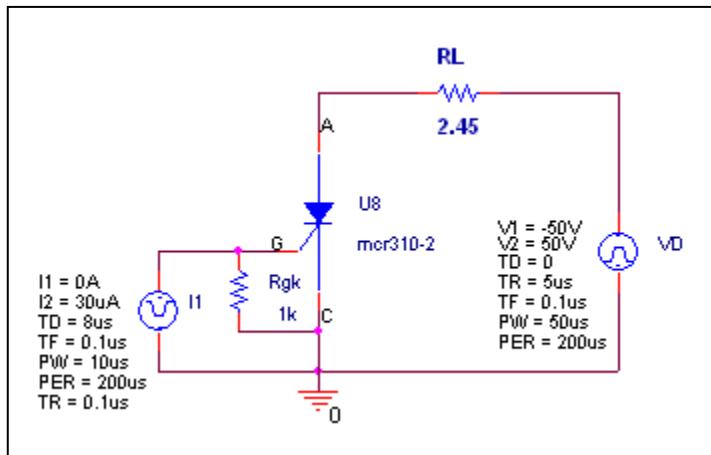


### Comparison Table

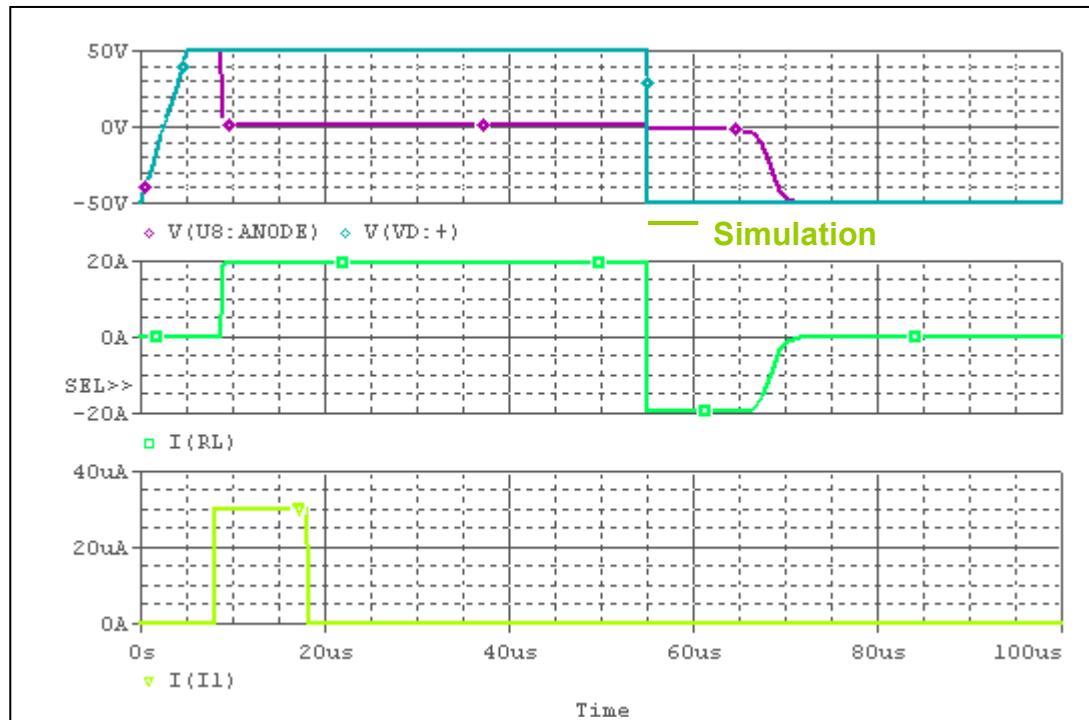
VD=12V	Measurement	Simulation	% Error
IH(mA)	6(max)	5.9184	-1.3600

## Switching Time Characteristic

Evaluation Circuit



Simulation result



Comparison Table

	Measurement	Simulation	%Error
Ton(us)	1	1.0067	0.6700